



Gaining Proficiency in World-Class BOM Management



May 17-18, 2012

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Session Outline



During this proficiency training course:

Attendees will be given guidance and instruction intended to aid their organization in the strategic implementation of a proactive Bill Of Material (BOM) Management approach designed to identify, analyze and resolve current and impending part availability risks associated with obsolescence.

2012 National Defense Authorization Act



One Hundred Twelfth Congress
of the
United States of America

AT THE FIRST SESSION

*Begun and held at the City of Washington on Wednesday,
the fifth day of January, two thousand and eleven*

An Act

To authorize appropriations for fiscal year 2012 for military activities of the Department of Defense, for military construction, and for defense activities of the Department of Energy, to prescribe military personnel strengths for such fiscal year, and for other purposes.

*Be it enacted by the Senate and House of Representatives of
the United States of America in Congress assembled,*

SECTION 1. SHORT TITLE.

This Act may be cited as the "National Defense Authorization Act for Fiscal Year 2012".

Section 818: Detection and Avoidance of Counterfeit Electronic Parts

- *Requires...processes to abolish counterfeit parts*
- *Requires...the use of trusted suppliers*
- *Requires...the design, operation, and maintenance of systems to detect and avoid counterfeit electronic parts*
- *Requires...standards and processes for identifying such trusted suppliers comply with established industry standards*



Industry Standards

SAE Aerospace An SAE International Group	AEROSPACE STANDARD	SAE AS5553
		Issued 2009-04
Counterfeit Electronic Parts; Avoidance, Detection, Mitigation, and Disposition		

RATIONALE

This standard was created in response to a significant and increasing volume of counterfeit electronic parts entering the aerospace supply chain, posing significant performance, reliability, and safety risks.

This standard was created to provide uniform requirements, practices and methods to mitigate the risks of receiving and installing counterfeit electronic parts.

FOREWORD

To assure customer satisfaction, aerospace industry organizations must produce, and continually improve, safe, reliable products that meet or exceed customer and regulatory authority requirements. The globalization of the aerospace industry and the resulting diversity of regulatory requirements has complicated this objective. End-product organizations face the challenge of assuring the quality and integration of product purchased from suppliers throughout the world and at all levels within the supply chain. Aerospace suppliers and processors face the challenge of delivering product to multiple customers having varying quality expectations and requirements.

This document standardizes requirements, practices, and methods related to: parts management, supplier management, procurement, inspection, test/evaluation, and response strategies when suspected or confirmed counterfeit parts are discovered.

SAE AS5553

- *Obsolescence can increase the risk of acquiring counterfeit electronic parts. To reduce the likelihood of purchasing counterfeit parts, electronic equipment manufacturers should proactively manage the life cycle of their products through the use of a Diminishing Manufacturing Sources and Material Shortages (DMSMS) management plan.*

- *The processes shall maximize availability of authentic, originally designed and/or qualified parts throughout the product's life cycle, including management of parts obsolescence.*

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Meet Regulatory and Industry Specified Compliancy



IHS can help by providing the required tools and content for:

- *Effective BOM Management which critical in mitigating costs and risks associated with counterfeit and obsolete components and proactive identification of current and impending part availability changes.*



IHS BOM Manager

With the IHS BOM Manager tool and Electronic Components Database, customers can:

- *Identify obsolescence and counterfeit risks as early as possible*
- *Identify alternate parts, sources and aftermarket manufacturers*
- *Manage and evaluate suppliers in a Approved Manufacturer List (AML)*
- *Receive part status, counterfeit, PCN/EOL, GIDEP notices, and price/availability updates*

IHS Electronic Components Database



The Electronics Database contains component information on over 300 million electronic components, from more than 1,500 manufacturers representing over 450 part categories:

- *Batteries*
- *Connectors*
- *Crystals / Oscillators*
- *Cylindricals*
- *Electro-Mechanical Components*
- *Fans & Blowers*
- *Fasteners & Hardware*
- *Fiber Optic Connectors*
- *Fiber Optic Devices*
- *Fuses & Circuit Protection*
- *Heat Sinks*
- *Sensors*
- *Passive Devices*
- *Power Supplies*
- *Relays*
- *RF Microwave Devices*
- *Semiconductors*
- *Transformers*

BOM Manager – Home Page



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BOM Import Status

BOM Name	Status	Mfr Exceptions	P/N Exceptions
TS3 - AMS-2300-0113-01	Processed	1	2
Qtest1	Processed	0	30
PM RA all 4	Processed	1	4
PM RI Power Amp Assy	Processed	0	0
Aug demo Cooper	Processed	4	44
Test_Fastener1	Processed	0	2
Brian indentured	Processed	0	0
PM ADT sample	Processed	12	3
Test_BlankRowsInBetween	Processed	1	4
EM Sample KS	Processed	9	62
CW Sample KS	Processed	6	78

BOM Alert History

Alert Date	BOM Name	Alerts	Alerts	Alerts	Alerts	Alerts
25-Aug-2010	BEL-Trans	3	0	0	3	0
25-Aug-2010	Bobby	2	0	0	2	0
25-Aug-2010	Chris	1	0	0	0	1
25-Aug-2010	For And	2	0	0	2	0
25-Aug-2010	GD Test	2	0	0	2	0
25-Aug-2010	GD UK	1	0	0	0	1
25-Aug-2010	GDsmp	2	0	0	2	0
25-Aug-2010	Invens	2	0	0	2	0
25-Aug-2010	Logitech	2	0	0	2	0
25-Aug-2010	NGI ana	2	0	0	2	0
25-Aug-2010	PM Bre	2	0	0	2	0
		13	0	0	13	0

BOM Summary

Discontinued				EOL				Available			
Total	Unique	With Alts	Without Alts	Total	Unique	Total	Unique	SS			
3890	3255	1213	2042	4	4	500	418	361	87	48	45
167	163	69	94	20	20	2060	2049	1967	82	14	14
3	3	1	2	0	0	31	31	30	1	0	0
130	130	97	33	4	4	86	86	71	15	0	0
2	2	2	0	0	0	115	115	111	4	0	0
14	14	6	8	1	1	102	101	96	5	3	3
11	11	8	3	0	0	12	12	12	0	0	0
189	186	88	98	8	8	1473	1464	1308	156	26	26
0	0	0	0	0	0	24	24	17	7	0	0
5	4	3	1	0	0	71	63	60	3	0	0
3	3	0	3	0	0	7	7	4	3	1	1
32	32	0	32	0	0	273	272	85	187	4	4
4	4	3	1	0	0	65	63	60	3	0	0
0	0	0	0	0	0	4	4	3	1	1	1
1	1	1	0	0	0	14	14	13	1	3	3
8	8	3	5	0	0	88	88	87	1	3	3

Quickly navigate to the information you need:

- Identify parts of concern
- Monitor alerted parts

BOM Manager – AML Page



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4DONLINE BOM Manager User: Design Engineer Home | Manage & Import | Exceptions | Summary | Details | Alerts | Reports | Where Used | Preferences | Admin | **CAML** | Log Out | Help

Manage & Import View/Edit CAML Mfr Exceptions CAML Part Exceptions

Corporate Parts 4 items

Clr	Corp P/N	Corp Name	Mfr P/N	Mfr Name	Corp P/N Desc	Mfr
☐	352A98000A9040	EXAMPLE OEM MFR NAME	BCX70G	NXP	TRANSISTOR	NPI
☐	724A90638A9120	EXAMPLE OEM MFR NAME	235050110102	YAGEO	RESISTOR	TR
☐	351A91847A9010	EXAMPLE OEM MFR NAME	TC74HC112AP	TOSHIBA AMERICA	MICROCIRCUIT,DIGITAL	DU
☐	1234567890		0987654321			

4 items Delete Add Cancel Edit Save Process CAML Clear Filters Show Edited Parts Search

AML Parts (Preferred Part is in bold font) 21 items

Clr	Mfr P/N	Mfr Name	Mfr P/N Desc
☐	SN54HC112J	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	TC74HC112AP	TOSHIBA	DUAL J-K FLIP FLOP WITH PRESET AND CLEAR
☐	CD74HC112EE4	TI	DUAL J-K FLIP-FLOP WITH SET AND RESET NEGATIVE-EDGE TRIGGER
☐	M54HC112D1	ST MICRO	RAD-HARD DUAL J-K FLIP FLOP WITH PRESET AND CLEAR
☐	CD74HC112E	TI	DUAL J-K FLIP-FLOP WITH SET AND RESET NEGATIVE-EDGE TRIGGER
☐	HD74HC112P	RENESAS TECH	DUAL J-K FLIP-FLOP (WITH PRESET AND CLEAR)
☐	74HC112N,652	NXP	DUAL JK FLIP-FLOP WITH SET AND RESET; NEGATIVE-EDGE TRIGGER
☐	M38510/65305BEA	TI	MICROCIRCUIT, DIGITAL, H SPEED, CMOS, DUAL JK NEG-EDGE TRIGGERED FF W/ CLR AND PRESET, ML SILICON
☐	SNJ54HC112J	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	933669270652	NXP	DUAL JK FLIP-FLOP WITH SET AND RESET; NEGATIVE-EDGE TRIGGER
☐	8408801EA	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	SN74HC112NE4	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	74HC112N	NXP	DUAL JK FLIP-FLOP WITH SET AND RESET; NEGATIVE-EDGE TRIGGER
☐	TC74HC112AP	TOSHIBA AMERICA	DUAL J-K FLIP-FLOP WITH PRESET AND CLEAR
☐	JM38510/65305BEA	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	M54HC112D	ST MICRO	RAD-HARD DUAL J-K FLIP FLOP WITH PRESET AND CLEAR
☐	8408801EX	TI	MICROCIRCUIT, DIGITAL, HIGH-SPEED CMOS, DUAL J-K FLIP-FLOP WITH SET AND RESET, MONOLITHIC SILICON
☐	CD54HC112F3A	TI	DUAL J-K FLIP-FLOP WITH SET AND RESET NEGATIVE-EDGE TRIGGER
☐	SN74HC112N	TI	DUAL J-K NEGATIVE-EDGE-TRIGGERED FLIP-FLOP WITH CLEAR AND PRESET
☐	74HC112NB	NXP	

21 items Set Preferred Delete Add Mfr Part Save Cancel Edit

Approved Manufacturer List (AML):

- Create and manage your corporate AVL – Reduce part number and supplier redundancy



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Part Numbers: CRCW06033906FKEA Mfr Na

Part Documents

Document Title
A) CRCW0603, DATASHEET (2009/01/23)
A) CRCW0603, DATASHEET (2008/11/05)
A) CRCW0603, DATASHEET (2008/11/05)
A) CRCW0603, DATASHEET (2008/11/04)
A) CRCW0603, DATASHEET (2008/09/10)
A) CRCW0603, DATASHEET (2008/03/25)
A) CRCW0603, DATASHEET (2008/02/14)
A) CRCW0603, DATASHEET (2007/07/04)
A) CRCW, DATASHEET (2007/03/05)
A) CRCW, DATASHEET (2007/01/24)
A) CRCW0603, DATASHEET (2006/10/10)
A) CRCW, DATASHEET (2006/03/09)
A) CRCW0603, DATASHEET (2005/09/27)
A) CRCW, DATASHEET (2005/09/27)
A) CRCW, DATASHEET (2005/02/16)

Environmental Documents

Document Title
E3) STATEMENT REGARDING SVHC REPORTING OBLIGATIONS UNDER REACH (2009/03/04)

MMBT2369LT1, MMBT2369ALT1
Switching Transistors
NPN Silicon

Features:
• Pb-Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CE}	15	VDC
Collector-Emitter Voltage	V _{CE}	40	VDC
Collector-Base Voltage	V _{CB}	40	VDC
Emitter-Base Voltage	V _{EB}	4.5	VDC
Collector Current - Continuous	I _C	200	mA

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation (Pb-Free Board)	P _D	225	mW
Thermal Resistance, Junction-to-Ambient	R _{JA}	556	°C/W
Total Device Dissipation (Alumina Substrate, Pb-Free)	P _D	300	mW
Thermal Resistance, Junction-to-Ambient	R _{JA}	417	°C/W
Junction and Storage Temperature	T _J , T _{STG}	-55 to +150	°C

Stresses exceeding maximum ratings may damage the device. Maximum ratings are stress ratings only. Functional operation above the recommended operating conditions is not implied. Extended exposure to stresses above the recommended operating conditions may affect device reliability.

1. P_D = 1.0 x 0.75 x 0.002 in.
2. Alumina = 0.4 x 0.3 x 0.002 in. 50.5% alumina.

MARKING DIAGRAMS

xxx M =
M = Date Code
= Pb-Free Package
(Note: Markings may be in either location)
*Date Code orientation and/or location may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping
MMBT2369LT1	SOT-23	3000/Tape & Reel
MMBT2369ALT1	SOT-23 (Pb-Free)	3000/Tape & Reel
MMBT2369LT1	SOT-23	3000/Tape & Reel
MMBT2369ALT1	SOT-23 (Pb-Free)	3000/Tape & Reel

For information on tape and reel specifications, including part orientation and tape size, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011D.

Preferred devices are recommended choices for future use and are current values.

Publication Order Number: MMBT2369LT1D

Publication Date
28-Jan-2009
05-Nov-2008
05-Nov-2008
04-Nov-2008
10-Sep-2008
25-Mar-2008
14-Feb-2008
04-Jul-2007
05-Mar-2007
24-Jan-2007
26-Oct-2006
10-Oct-2006
09-Mar-2006
27-Sep-2005
27-Sep-2005
16-Feb-2005

Publication Date
04-Mar-2009

Easy access to part information:

- **Datasheets**
- Lifecycle
- Alerts / Notices
- Technical attributes
- Alternates

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BOM Details	Edit BOM Parts	P/N Details	Mfr Info	Mfrs	Documents	Life Cycle
Part Number: 5874LV8996PW Mfr Name: TI PS: A						
Category		Microprocessor IC:Other				
Manufacturer Part Description		3.3V 108 ADD-SCN PRT MTRDP-ADD TRNS				
Manufacturer Package Description		GREEN, PLASTIC, TSSOP-24				
CAGE Code		01295				
RoHS Compliant		YES				
RoHS Exemption(s)						
SVHC Presence		NO-SBE ENV DOC				
POSL Presence		NO-SBE ENV DOC				
China RoHS Compliant		YES				
Lead Free		YES				
Generic Number		74LV8996				
Microprocessor Circuit Type		MICROPROCESSOR CIRCUIT				
Qualification Status		COMMERCIAL				
Temperature Grade		INDUSTRIAL				
Supply Voltage-Nom (Vsup) (V)		3				
Supply Voltage-Min (Vsup) (V)		2.7				
Supply Voltage-Max (Vsup) (V)		3.6				
Technology		BICMOS				
Number of Functions		1				
Package Code		TSSOP				
JEDEC-30 Code		E-PDSO-G24				
Package Shape		RECTANGULAR				
Package Body Material		PLASTIC/EPOXY				
Terminal Position		DUAL				
Package Style		SMALL OUTLINE, THIN PROFILE, SHRINK PITCH				
Terminal Form		GULL WING				
Number of Terminals		24				
Surface Mount		YES				
Length (mm)		7.5				
Width (mm)		4.4				
Seated Height-Max (mm)		1.2				
Terminal Pitch (mm)		0.53				

Easy access to part information:

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BOM Manager

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BOM Details	P/N Details	Mfr Info	Mfrs	Documents	Life Cycle
Part Number: NE570D Mfr Name: On Semi PS: E					
Part Number		NE570D			
Mfr Name		On Semi			
Life Cycle Stage		PHASE-OUT			
Life Cycle Code		4.9			
Availability(YTEOL)		< 1			
Estimated YTEOL		0.4			
LTB Date					
LTD Date					
Alert/Prediction Date					
Life Cycle Information Source		MANUFACTURER			
Comments		LTB WHILE SUPPLY LAST			

Easy access to part information:

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- [illegible]

- Datasheets
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- Technical attributes
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User: Design Engineer

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Part Number: HLF1644SP3 Part Name: Fairchild PS: 2

End Of Life

IHS Alert Number	LTD Date	LTD Date	Information Source	Alert/Prediction Date
1547422049	04-Dec-2009	04-Jun-2010	MANUFACTURER	04-Jun-2009

Product Change Notices

IHS Alert Number	Number	Description	Type	Issue Date
1698879829	Q4074805-A	ALTERNATE FABRICATION SITE	PRODUCT CHANGE NOTIFICATION	28-Feb-200
1740810822	Q4074805	ALTERNATE FAB LOCATION, METALLIZATION MATERIAL	PRODUCT CHANGE NOTIFICATION	17-Dec-200
1668371476	Q3073211	TRANSFER OF THE ASSEMBLY & TEST PROCESSES OF T0210/T0262/T0263 DEVICES FROM MALAYSIA TO CHINA	PRODUCT CHANGE NOTIFICATION	24-Aug-200
2093796243	Ra-C-06-20	INCLUSION OF THE WORDS "LEAD FREE" ON LABELS PLACED ON REELS AND INTERNAL BOXES	PRODUCT CHANGE NOTIFICATION	15-May-200
2119014659	20044801	PSA COVER TAPE WILL BE USED AS AN ALTERNATIVE COVER TAPE APART FROM HMA COVER TAPE	PRODUCT CHANGE NOTIFICATION	05-Jun-200
2037915788	X1-C-05-237	PSA COVER TAPE WILL BE USED AS AN ALTERNATE COVER TAPE APART FROM HMA FOR THE TAPE AND REEL PROCESS	PRODUCT CHANGE NOTIFICATION	05-Jun-200
2009655302	20041503-A	STANDARDIZING AND IMPLEMENTING COMMON MARKING STANDARDS AND LAY-OUT	PRODUCT CHANGE NOTIFICATION	01-Jun-200
2009655300	20041802	QUALIFYING FAIRCHILD SEMICONDUCTOR (SUZHOU) CO., LTD, AS ALTERNATE/ ADDITIONAL ASSEMBLY & TEST SITE	PRODUCT CHANGE NOTIFICATION	21-May-200
2008138406	2004181	STANDARDIZING AND IMPLEMENTING COMMON MARKING STANDARDS AND LAY-OUT	PRODUCT CHANGE NOTIFICATION	12-May-200
1997655428	20040204	QUALIFY FAIRCHILD SEMICONDUCTOR (SUZHOU) CO., LTD AS AN ADDITIONAL/ALTERNATE SITE	PRODUCT CHANGE NOTIFICATION	13-Feb-200
1987773960	20033604	FAIRCHILD SEMICONDUCTOR CEBU, PHILIPPINES IS BEING QUALIFIED AS AN ADDITIONAL ASSEMBLY AND TEST SITE	PROCESS CHANGE NOTIFICATION	07-May-200
1987957410	20033903	PLANNING TO CHANGE THE GATE BONDING WIRE FROM 5 MILS/6 MILS TO 2 MILS OR 6 MILS TO 5 MILS	PROCESS CHANGE NOTIFICATION	24-Oct-200
1678278902	20033807	ALTERNATE ASSEMBLY/TEST LOCATION/QUALIFICATION CHANGE	PRODUCT CHANGE NOTIFICATION	06-Oct-200
1987555415	X1-C-04-51	QUALIFICATION OF FAIRCHILD SEMICONDUCTOR (SUZHOU) CO., LTD, AS AN ALTERNATE/ADDITIONAL ASSEMBLY	PROCESS CHANGE NOTIFICATION	06-Oct-200
1948744147	20023503	PACKAGE CHANGE	PROCESS CHANGE NOTIFICATION	17-Sep-200
1947346886	20023403	MARKING FORMAT OR CONTENT	PROCESS CHANGE NOTIFICATION	09-Sep-200
1817903352	20021801	ASSEMBLY PLANT CODE ASSIGNED TO IDENTIFY PARTS	PROCESS CHANGE NOTIFICATION	01-May-200
1937610313	20020911-A	ALTERNATE ASSEMBLY/TEST LOCATION/QUALIFICATION	PROCESS CHANGE NOTIFICATION	22-Apr-200
1936712008	20020911	ALTERNATE ASSEMBLY, TEST LOCATION AND QUALIFICATION	PROCESS CHANGE NOTIFICATION	26-Mar-200
1907631463	20012301	INTERLIS LOGO (I) WILL BE REPLACED WITH THE FAIRCHILD SEMICONDUCTOR LOGO (F)	PRODUCT CHANGE NOTIFICATION	13-Jul-2001

Easy access to part information:

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Where Used Search: Search Options

Internal P/N: Matched Mfr P/N: 2N222*

Matched Mfr: Select value...

Imported Mfr P/N: Imported Mfr:

Reset Clear Search

Where Used Search: Results Summary 1 to 50 of Count Print Preview

Internal Part Number	Matched Mfr P/N	Matched Mfr	Imported Mfr P/N	Imported Mfr	BOM Quantity	QPEI	BOM Path
	2N222*						
IHS-000678591	2N2221	SEMELAB LTD	2N2221		1	1	Peter Morse > S
IHS-000678592	2N2221A	SEMELAB LTD	2N2221A		1	1	Peter Morse > S
IHS-017673498	2N2222	MICROSEMI CORP-LAWRENCE	2N2222	Microsemi LAW	1	1	Nathan test > Je
IHS-017673500	2N2222	RECTRON LTD	2N2222	Rectron	1	1	Nathan test > Je
IHS-017673478	2N2222	ON SEMICONDUCTOR	2N2222	On Semi	1	1	Nathan test > Je
IHS-006012663	2N2222	CENTRAL SEMICONDUCTOR CORP	2N2222	CENTRAL	1	1	Nathan test > N
55464	2N2222	CENTRAL SEMICONDUCTOR CORP	2N2222	CENTRAL	1		Nathan test > Tr
IHS-017673476	2N2222	CENTRAL SEMICONDUCTOR CORP	2N2222	Central Semi	1	1	Nathan test > Je
IHS-017673480	2N2222	MICRO ELECTRONICS LTD	2N2222	Micro Elek	1	1	Nathan test > Je
417/4/00397/768	2N2222	MICROSEMI CORP	2N2222	Microsemi	1	1	Brian S demo fo
IHS-014533130	2N2222	MICROSEMI CORP	2N2222	Microsemi	1	1	Brian S demo fo
417/4/00397/768	2N2222	MICROSEMI CORP	2N2222	Microsemi	1	1	Nathan test > Tr
IHS-017673481	2N2222	MICROSEMI CORP	2N2222	N E Semi	1	1	Nathan test > Je
IHS-017673502	2N2222	MICROSEMI CORP	2N2222	Microsemi	1	1	Nathan test > Je
1300019-001	2N2222	ADVANCED SEMICONDUCTOR INC	2N2222	ADVANCED SEMICONDUCTOR	1	1	Perry > Inven
IHS-017673469	2N2222	ADVANCED SEMICONDUCTOR INC	2N2222	ASI	1	1	Nathan test > Je
IHS-017673495	2N2222	SIEMENS A G	2N2222	Siemens	1	1	Nathan test > Je
IHS-017673482	2N2222	ELECTRONIC TRANSISTORS CORP	2N2222	ETC	1	1	Nathan test > Je
IHS-017673483	2N2222	HI-TRON SEMICONDUCTOR CORP	2N2222	Hi-Tron	1	1	Nathan test > Je
IHS-017673484	2N2222	INTERNATIONAL DEVICES INC	2N2222	Intl Devices	1	1	Nathan test > Je
IHS-017673485	2N2222	SWAMPSCOTT ELECTRONICS CO INC	2N2222	Swampscott	1	1	Nathan test > Je
IHS-017673473	2N2222	GENERAL DIODE CORP	2N2222	Gen Diode	1	1	Nathan test > Je

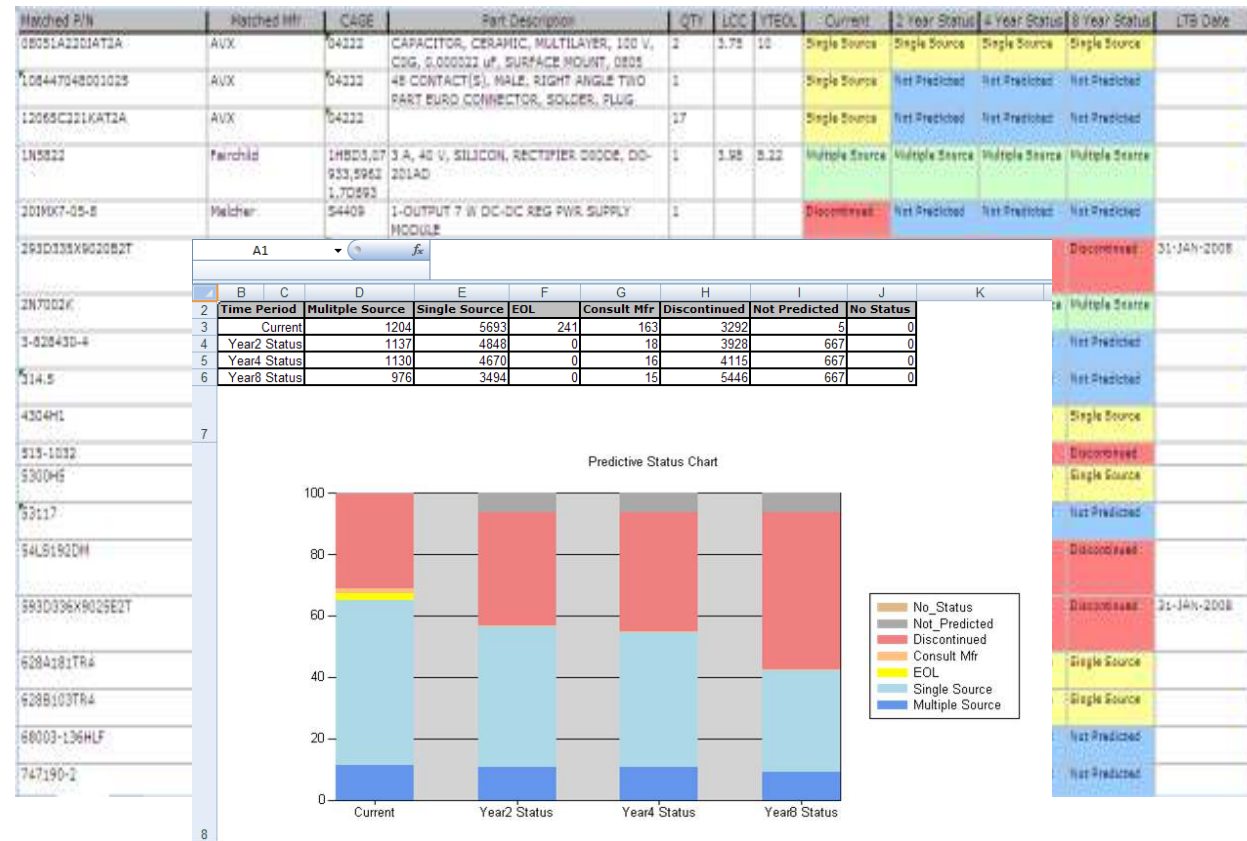
Identify other lists that are impacted by the same event:

- Search across lists using a variety of methods
- Identify duplicate parts

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- Email Notification
- ERAI Alerts



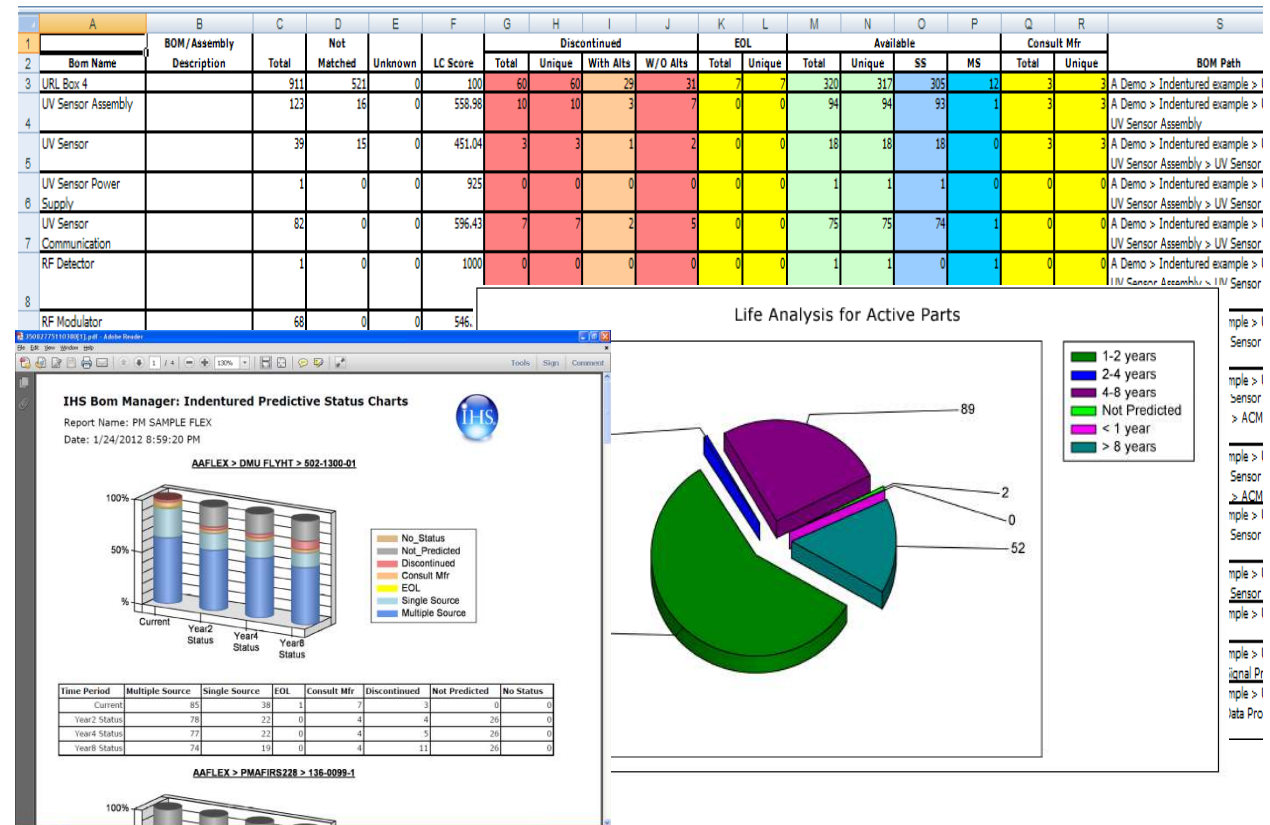
Easy access to specialized information:

- **Predicted Status**
- Health Analysis



BOM Manager – Reports Page

- Dashboard
- AML
- BOM Details
- Where Used
- Reports
- Email Notification
- ERAI Alerts



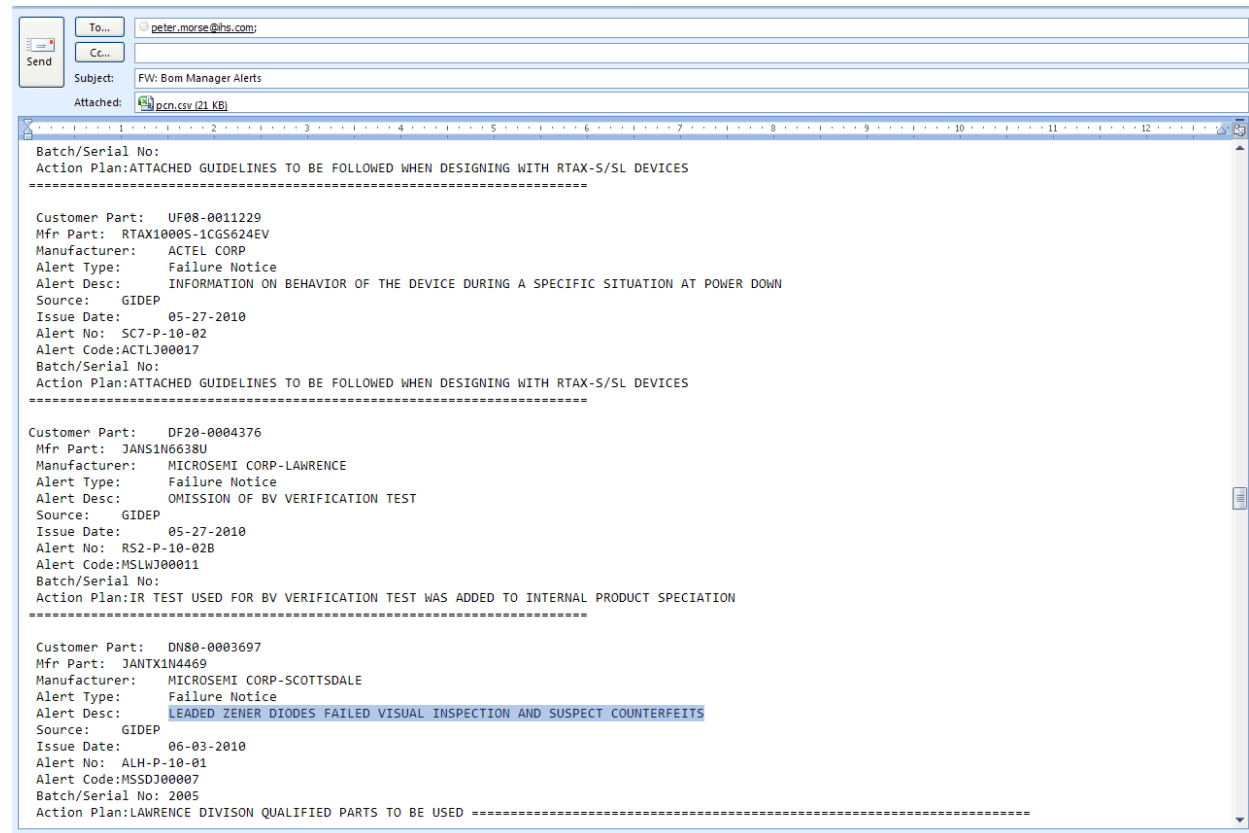
Easy access to specialized information:

- Predicted Status
- Health Analysis

BOM Manager – Notifications



- Dashboard
- AML
- BOM Details
- Where Used
- Reports
- Email Notification
- ERAI Alerts



Automatically Receive Email Notifications:

- Part availability changes, suspect counterfeit
- PCN and EOLs



BOM Manager – ERAI Alerts

- Dashboard
- AML
- BOM Details
- Where Used
- Reports
- Email Notification
- ERAI Alerts



Home Part Sourcing Company Search Reported Companies **Reported Parts** ERAI Member Search File a Complaint BOM Scrubber Services Executive Conference Customer Support User Manual

Search High Risk Parts Submit High Risk Part

Part: XC5210-5PG223C

Part Number: XC5210-5PG223C
Manufacturer: XILINX
Date Code: 0645
Lot Code: F38847A
Country of Origin: Philippines
Suspect Counterfeit: Yes
Date Reported: 08/12/2011

Description of Nonconformance:

Upon visual inspection it was noted that there were inconsistencies within this lot of components. These inconsistencies include the following:

1. Component top surface has a slightly rough texture and is lighter in color than the bottom surface.
2. There is a lack of markings on the bottom surface which is not consistent with known-good product from the same Xilinx product series
3. There is usually date code and lot code information located on the bottom side of xilinx components of this package style.
4. The device went EOL in 1999, with a last time ship from the factory of January 15th, 2002 -- the printed date code of "0645" could not be possible.
5. Scanning Electron Microscopy shows an easily visible difference between the top and bottom surfaces. When viewed at 5000x the top surface is not consistent with the normal ceramic patterns seen on the top and bottom of all ceramic component surfaces. The altered top-surface is consistent with ceramic surfaces which have undergone a lapping (resurfacing) process. (Lapping is the gradual removal of surface layers via constant pressure and a wet, abrasive compound to generate a smooth, uniform new surface.)

Note: Resistance to solvents (RTS) was not performed due to the likelihood of marking removal. This is a common occurrence for this type of component.

Available Images and Test/Nonconformance Reports:

Direct access to the ERAI web site for detailed counterfeit part activity

Next Steps



Part Obsolescence Management:

1. Gain access to a BOM Management tool to analyze parts and designs for potential risk and proactively monitor changes.
2. Improve your supply chain by identifying approved alternate sources and aftermarket manufacturers.
3. Apply Life Cycle forecasters to component selection decisions.
4. Utilize specialized reporting capabilities to help make informed decisions.
5. Evaluate parts for known counterfeit activity and suspect suppliers.

